LOW-VOLTAGE 10-BIT BUS-EXCHANGE SWITCH

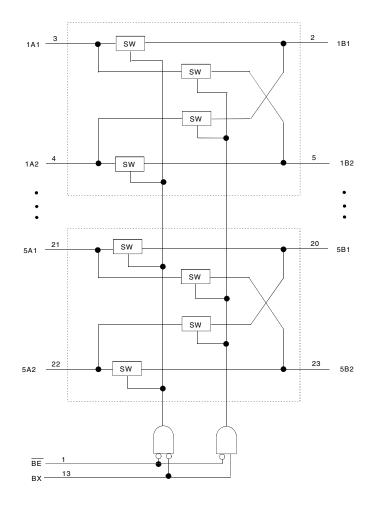
FEATURES:

- 5Ω A/B bi-directional bus switch
- · Isolation under power-off conditions
- Over-voltage tolerant
- Latch-up performance exceeds 100mA
- Vcc = 2.3V 3.6V, Normal Range
- ESD > 2000V per MIL-STD-883, Method 3015;
 > 200V using machine model (C = 200pF, R = 0)
- · Available in SSOP, QSOP and TSSOP packages

APPLICATIONS:

- 3.3V High Speed Bus Switching and Bus Isolation
- Crossbar Switching

FUNCTIONAL BLOCK DIAGRAM



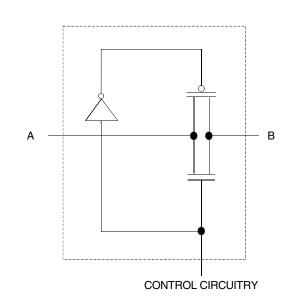
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DESCRIPTION:

The CBTLV3383 provides ten bits of high-speed bus switching or exchanging with low on-switch resistance of the switch allowing connections to be made with minimal propagation delay.

The device operates as a 10-bit bus switch or a 5-bit bus exchanger, which provides swapping of the A and B pairs of signals. The bus-exchange function is selected when BX is high and BE is low.

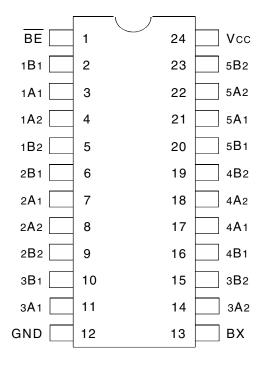
SIMPLIFIED SCHEMATIC, EACH SWITCH



AUGUST 2002

INDUSTRIALTEMPERATURERANGE

PINCONFIGURATION



SSOP/ QSOP/ TSSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
Vcc	SupplyVoltage Range	-0.5 to +4.6	V
Vi	Input Voltage Range	-0.5 to +4.6	V
	Continuous Channel Current	128	mA
Ік	Input Clamp Current, VI/O < 0	-50	mA
Tstg	Storage Temperature	-65 to +150	°C

NOTE:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

FUNCTION TABLE⁽¹⁾

Inp	out	Inputs/Outputs		
BE	ВΧ	1 A 1 - 5 A 1	1 A 2 - 5 A 2	
L	L	1B1 - 5B1	1B2 - 5B2	
L	Н	1B2 - 5B2	1B1 - 5B1	
Н	Х	Z	Z	

NOTE:

1. H = HIGH Voltage Level

X = Don't Care

L = LOW Voltage Level

Z = High Impedance

OPERATING CHARACTERISTICS, TA = $25^{\circ}C^{(1)}$

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
Vcc	Supply Voltage		2.3	3.6	V
Vih	High-Level Control Input Voltage	Vcc = 2.3V to 2.7V	1.7	—	V
		Vcc = 2.7V to 3.6V	2	_	
VIL	Low-Level Control Input Voltage	Vcc = 2.3V to 2.7V	—	0.7	V
		Vcc = 2.7V to 3.6V	—	0.8	
TA	Operating Free-Air Temperature		-40	85	°C

NOTE:

1. All unused control inputs of the device must be held at Vcc or GND to ensure proper device operation.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Conditions: $TA = -40^{\circ}C$ to $+85^{\circ}C$

Symbol	Parameter	Test Co	Test Conditions		Тур. ⁽¹⁾	Max.	Unit
Vik	Control Inputs, Data Inputs	Vcc = 3V, II = -18mA		-		-1.2	V
li	Control Inputs	VCC = 3.6V, VI = VCC or GND)		-	±1	μA
loz	Data I/O	VCC = 3.6V, VO = 0 or 3.6V, s	switch disabled	_	-	5	μA
IOFF		Vcc = 0, VI or Vo = 0 to 3.6V		_	-	10	μA
lcc		Vcc = 3.6V, Io = 0, VI = Vcc	Vcc = 3.6V, Io = 0, VI = Vcc or GND		-	10	μA
$\Delta ICC^{(2)}$	Control Inputs	Vcc = 3.6V, one input at 3V, o	Vcc = 3.6V, one input at 3V, other inputs at Vcc or GND		_	300	μA
Сі	Control Inputs	VI = 3V or 0	VI = 3V or 0		3.5	_	pF
CIO(OFF)		Vo = 3V or 0, BE = Vcc	$VO = 3V \text{ or } 0, \overline{BE} = VCC$		13.5	_	pF
	Vcc = 2.3V	VI = 0	lo = 64mA	_	5	8	
	Typ. at Vcc = 2.5V		lo = 24mA	_	5	8	
RON ⁽³⁾		VI = 1.7V	lo = 15mA	-	27	40	Ω
		VI = 0	lo = 64mA	-	5	7	
	Vcc = 3V		lo = 24mA	_	5	7	1
		VI = 2.4V	lo = 15mA	—	10	15	1

NOTES:

1. Typical values are at Vcc = 3.3V, +25°C ambient.

2. The increase in supply current is attributable to each current that is at the specified voltage level rather than Vcc or GND.

3. This is measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

SWITCHINGCHARACTERISTICS

		$Vcc = 2.5V \pm 0.2V$		Vcc = 3.3V ± 0.3V				
Symbol	Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
tpd ⁽¹⁾	Propagation Delay	-	-	0.15	-	-	0.25	ns
	A to B or B to A							
teo	Propagation Delay	1.5	-	5.8	1.5	-	4.7	ns
	BX to A or B							
ten	Output Enable Time	1.5	_	5.3	1.5	_	4.7	ns
	BE to A or B							
tois	Output Disable Time	1	_	6	1	-	6	ns
	BE to A or B							

NOTE:

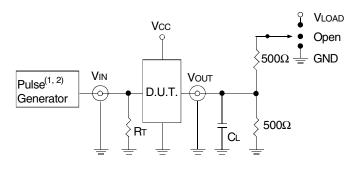
1. The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance driven by an ideal voltage source (zero output impedance).

IDT74CBTLV3383 LOW-VOLTAGE 10-BITBUS-EXCHANGE SWITCH

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	$Vcc^{(1)} = 3.3V \pm 0.3V$	Vcc ⁽²⁾ =2.5V±0.2V	Unit
Vload	6	2 x Vcc	V
Vih	3	Vcc	V
Vτ	1.5	Vcc / 2	V
Vlz	300	150	mV
Vhz	300	150	mV
Cl	50	30	pF



Test Circuits for All Outputs

DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

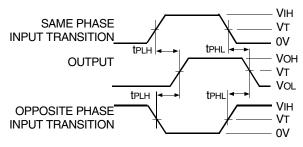
NOTES:

1. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2.5ns; tR \leq 2.5ns.

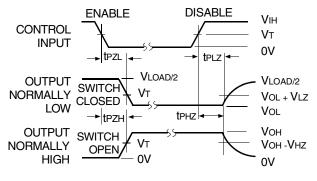
2. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2ns; tR \leq 2.5ns.

SWITCH POSITION

Test	Switch
tplz/tpzl	Vload
tрнz/tрzн	GND
ted	Open

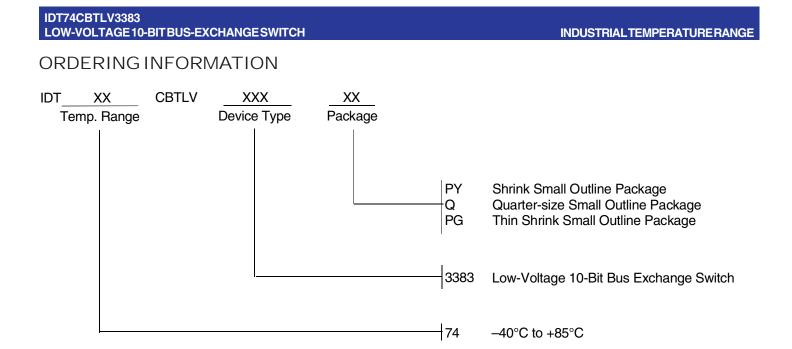






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